

FIG. 1A

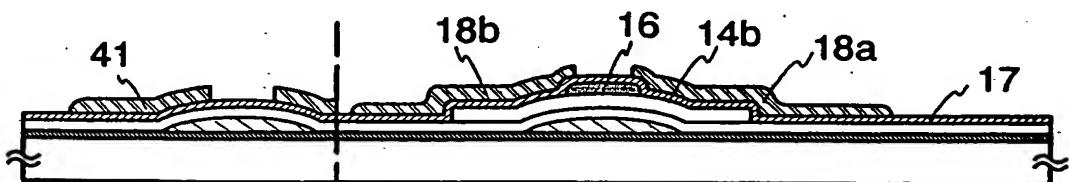


FIG. 1B

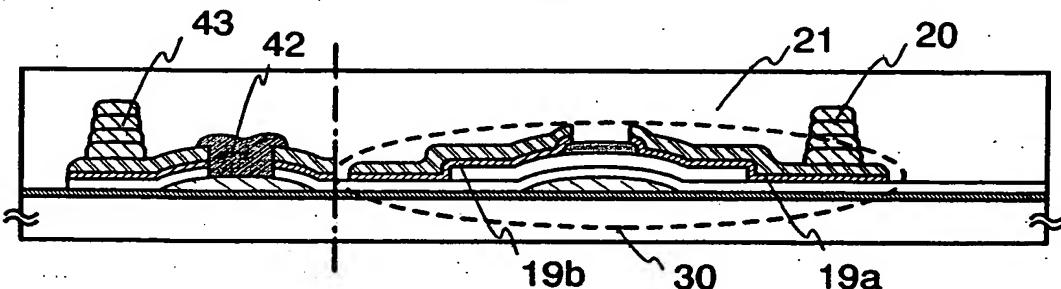


FIG. 1C

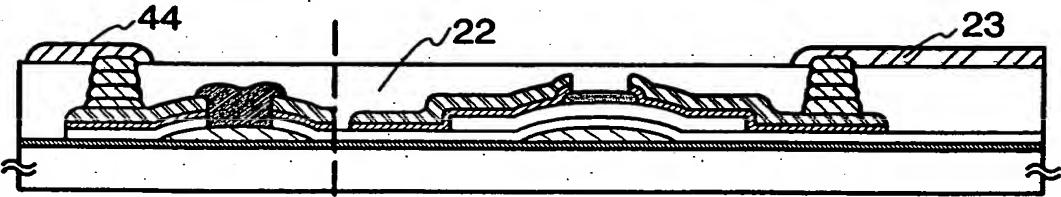


FIG. 1D

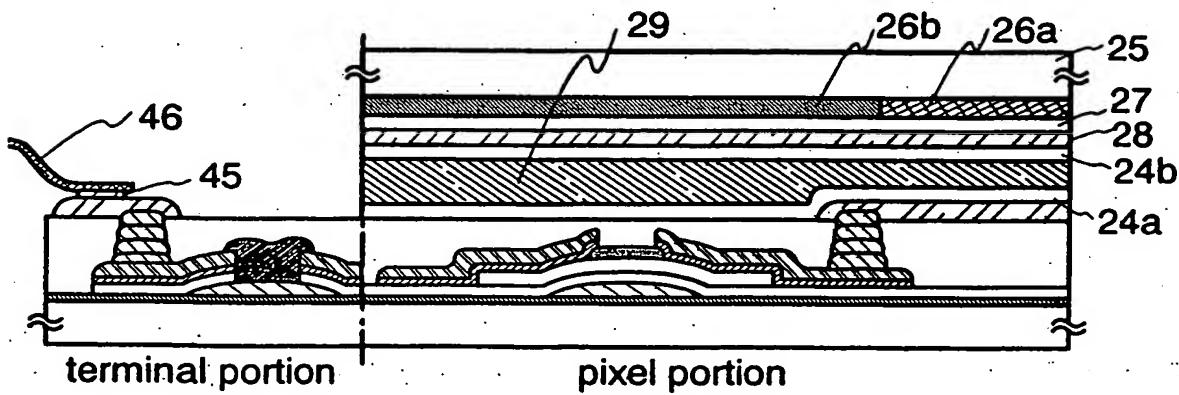


FIG. 1E

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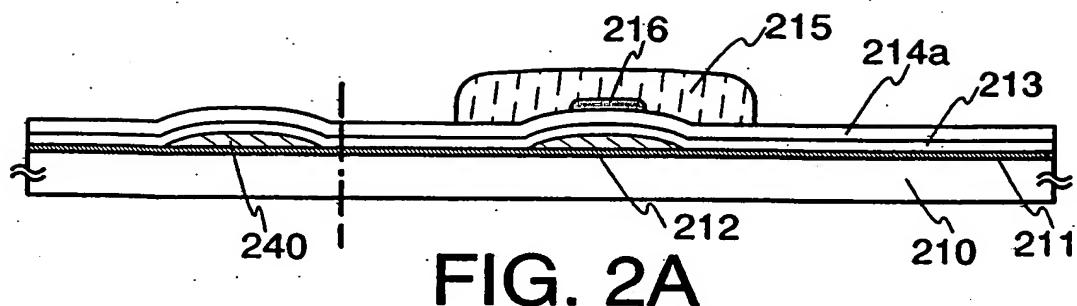


FIG. 2A

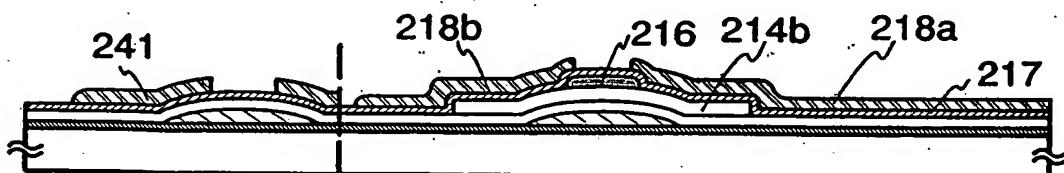


FIG. 2B

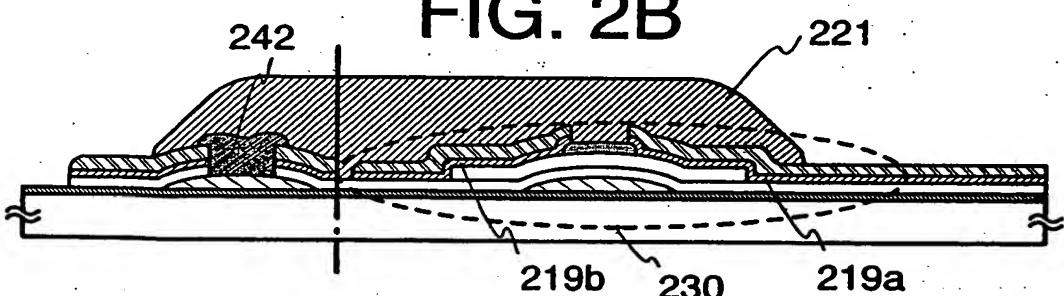


FIG. 2C

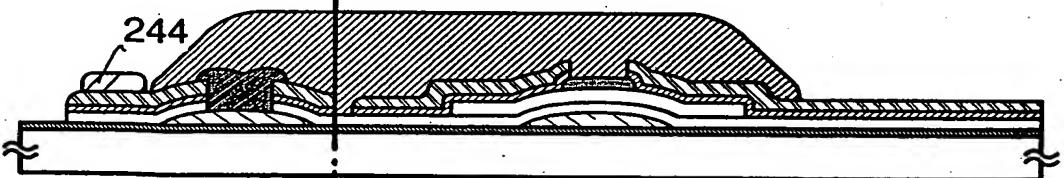


FIG. 2D

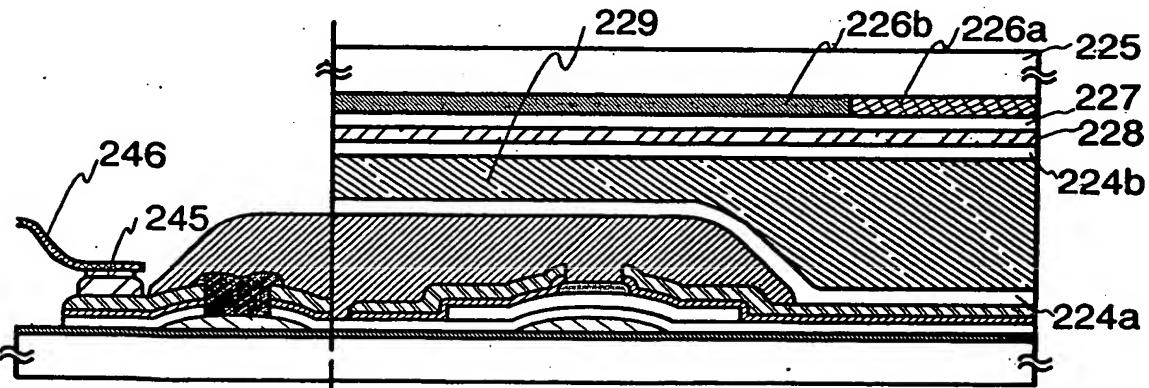


FIG. 2E

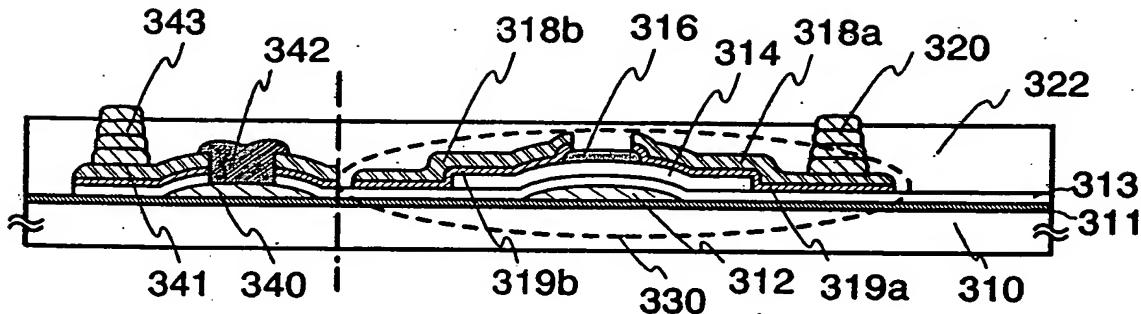


FIG. 3A

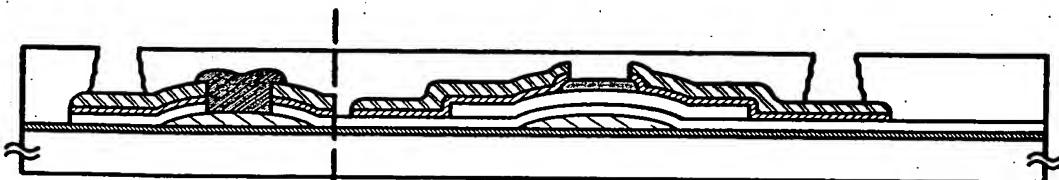


FIG. 3B

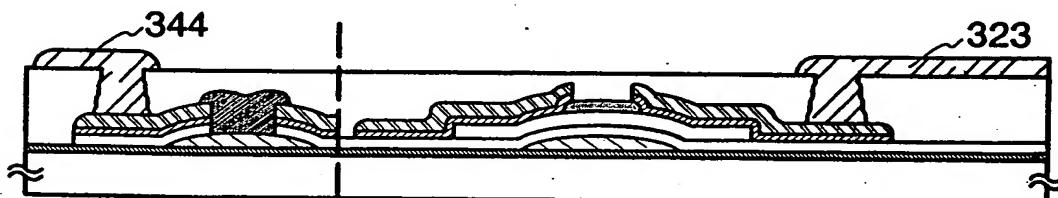


FIG. 3C

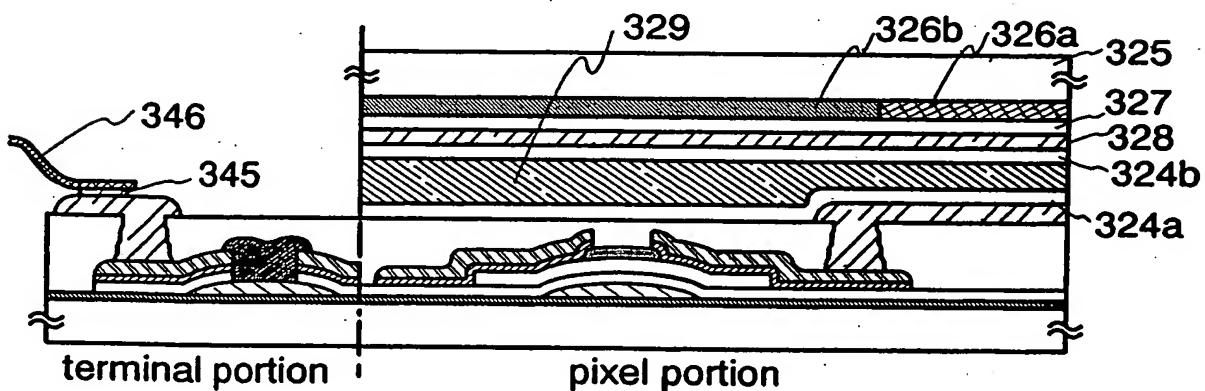


FIG. 3D

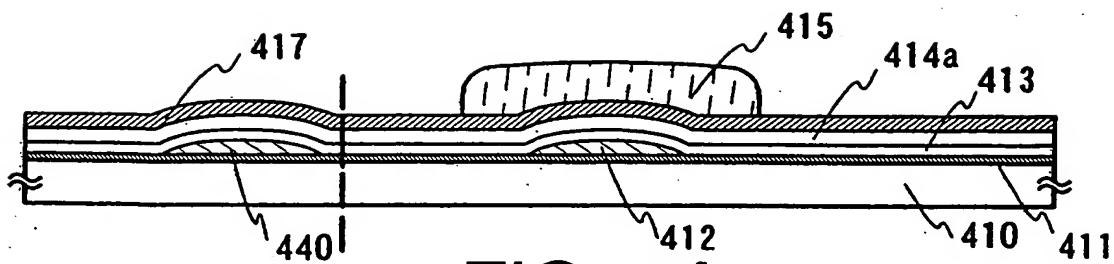


FIG. 4A

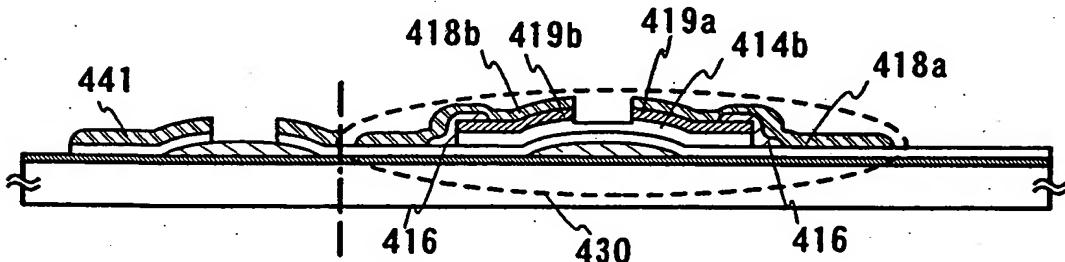


FIG. 4B

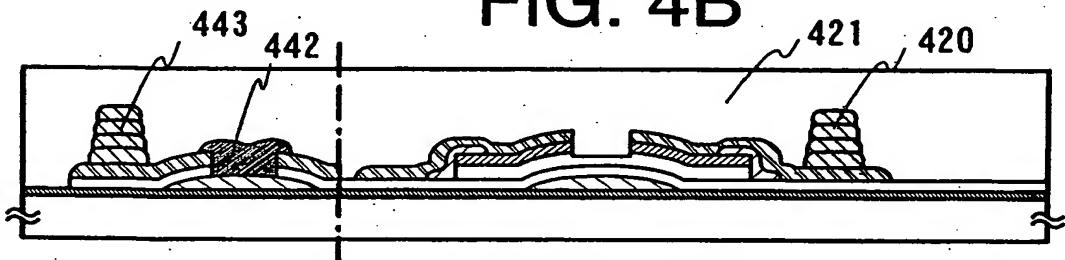


FIG. 4C

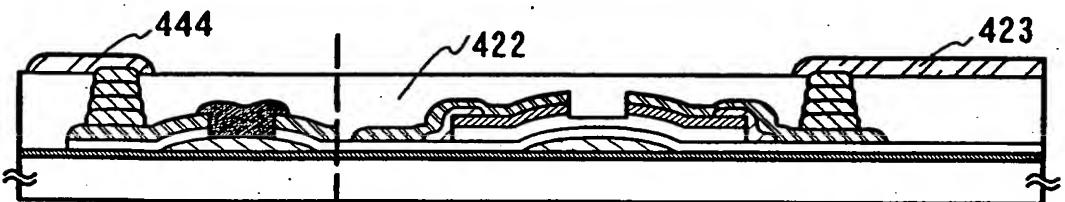


FIG. 4D

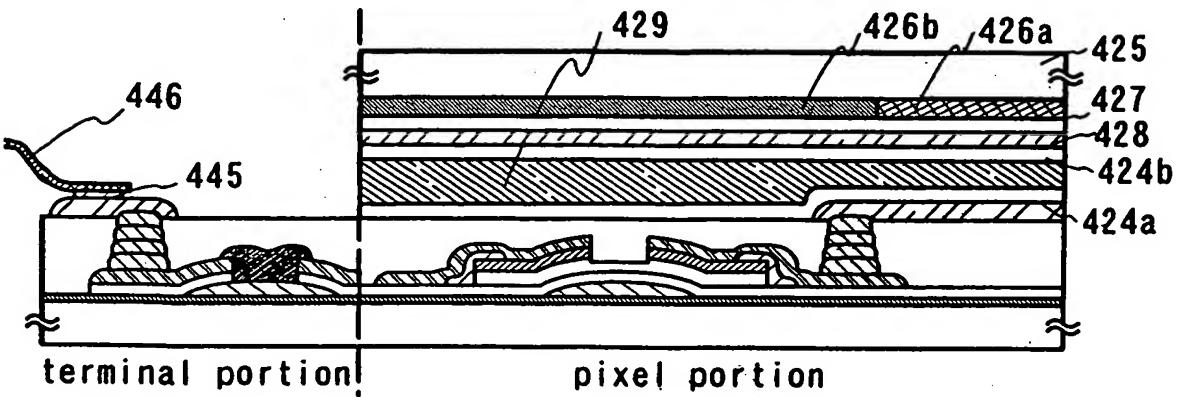


FIG. 4E

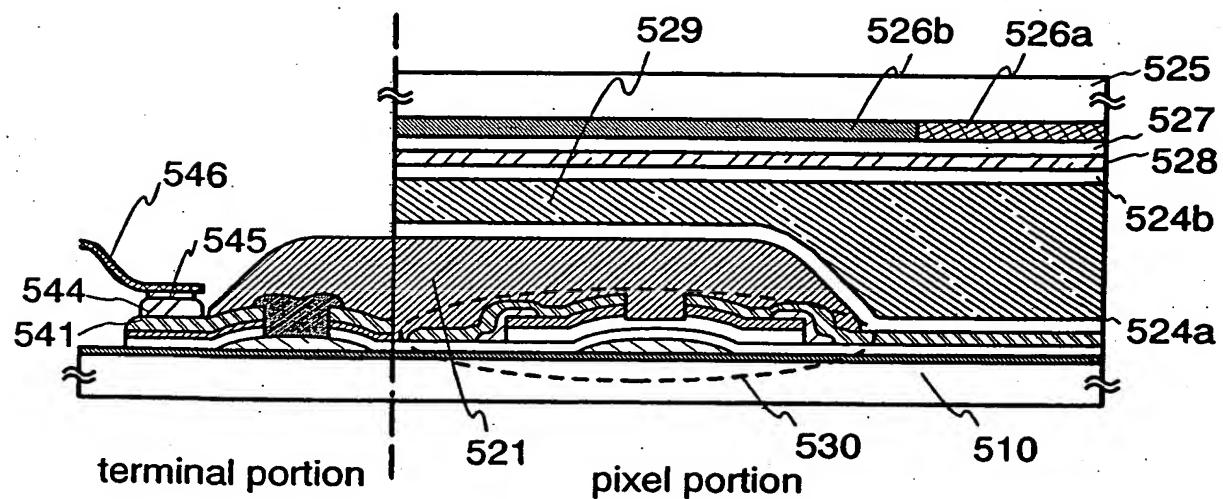


FIG. 5

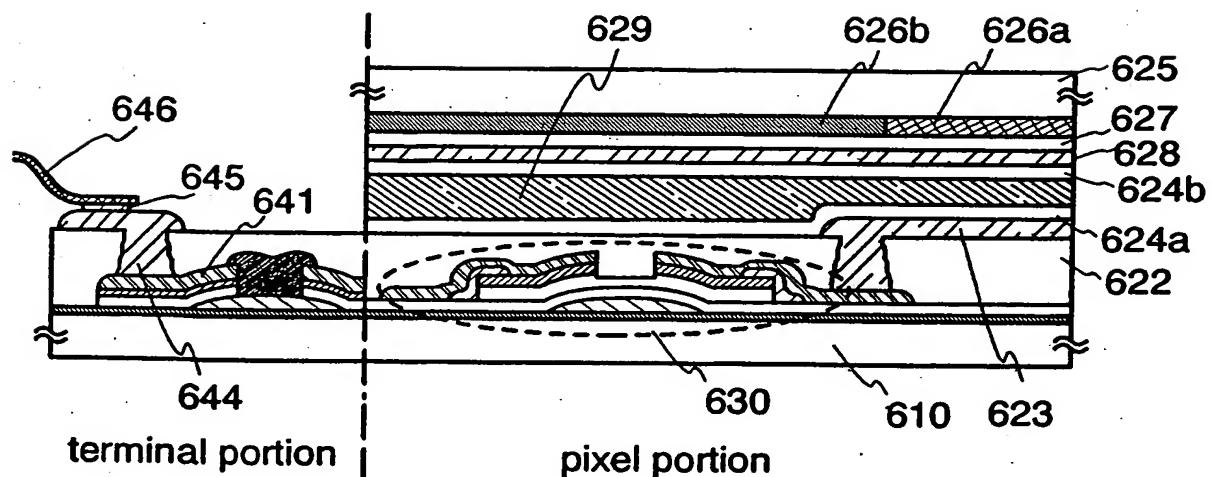


FIG. 6

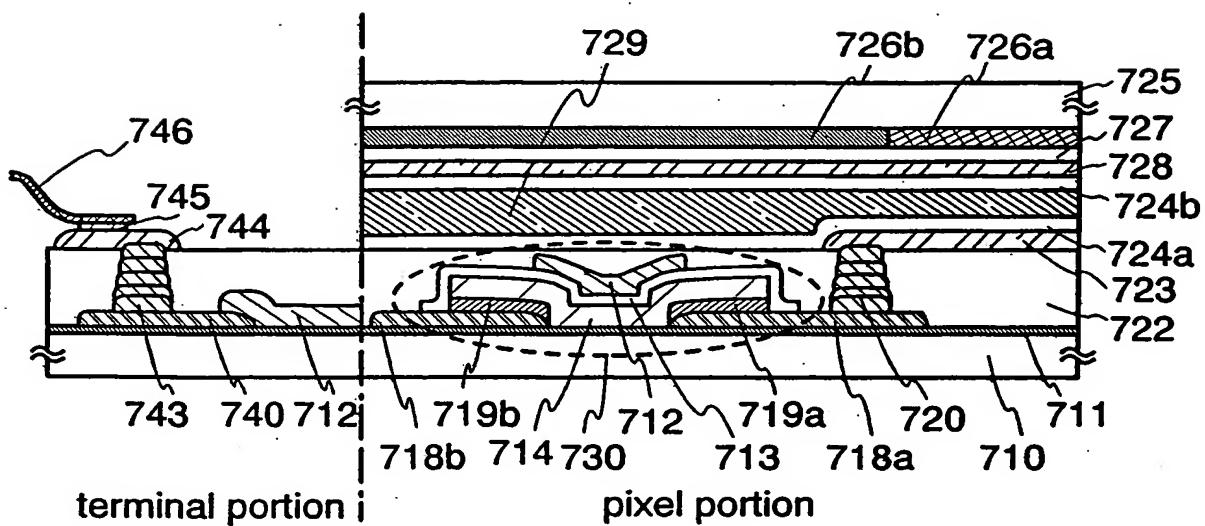


FIG. 7

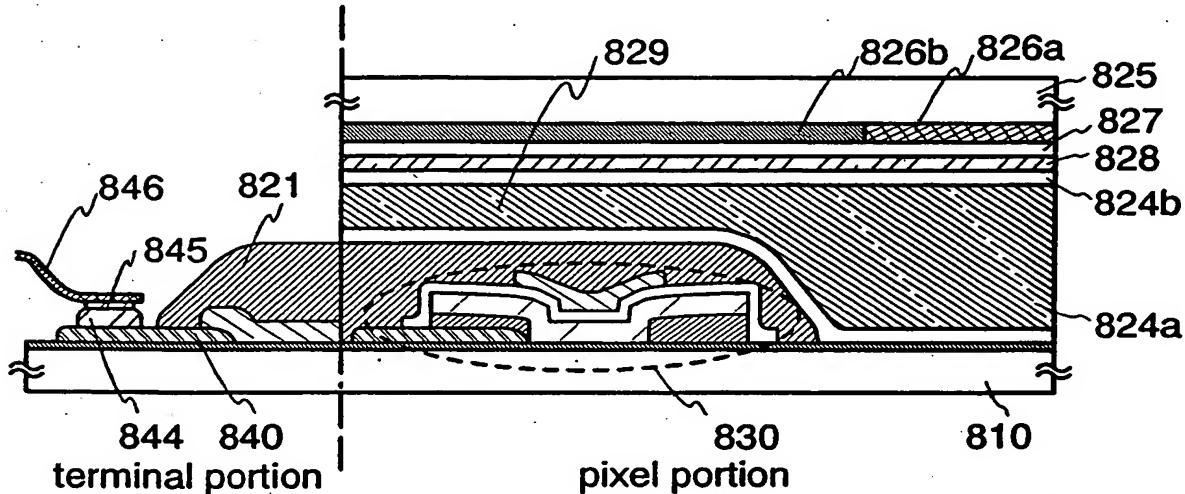


FIG. 8

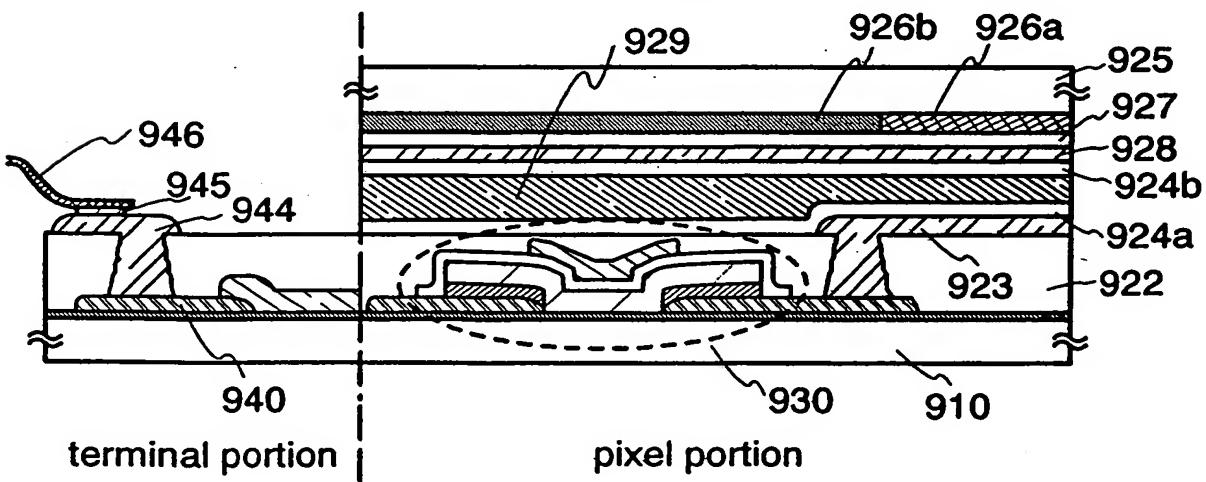


FIG. 9

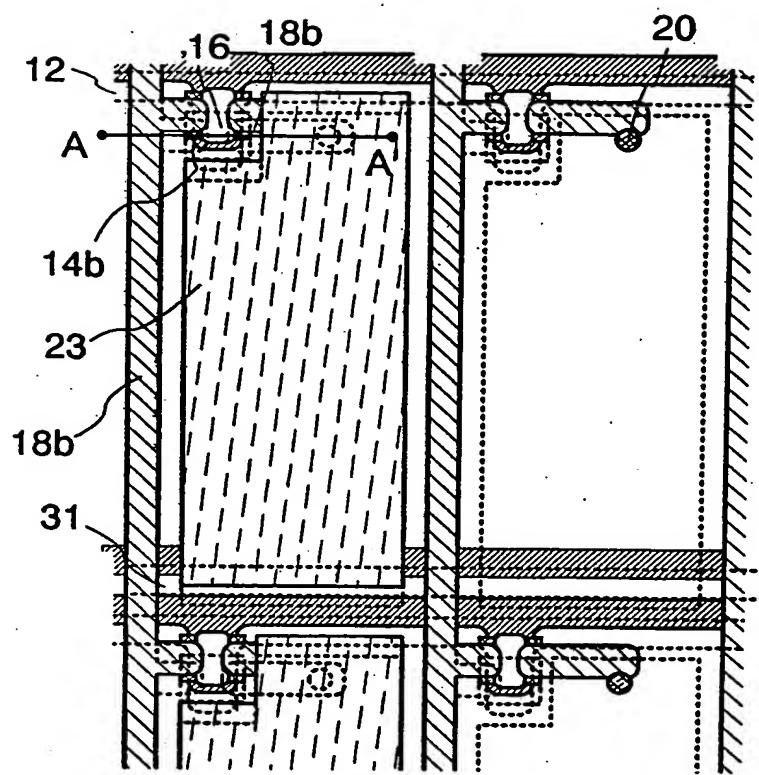


FIG. 10

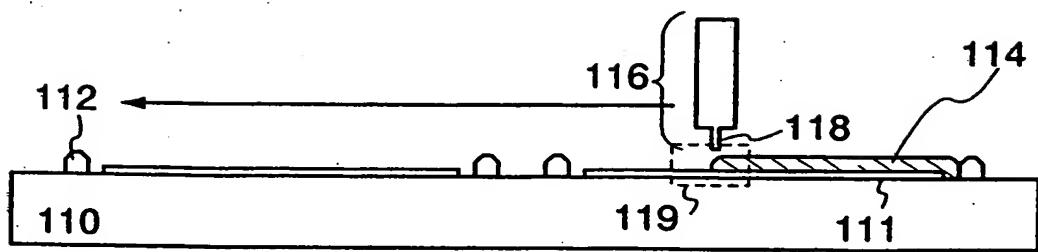


FIG. 11A

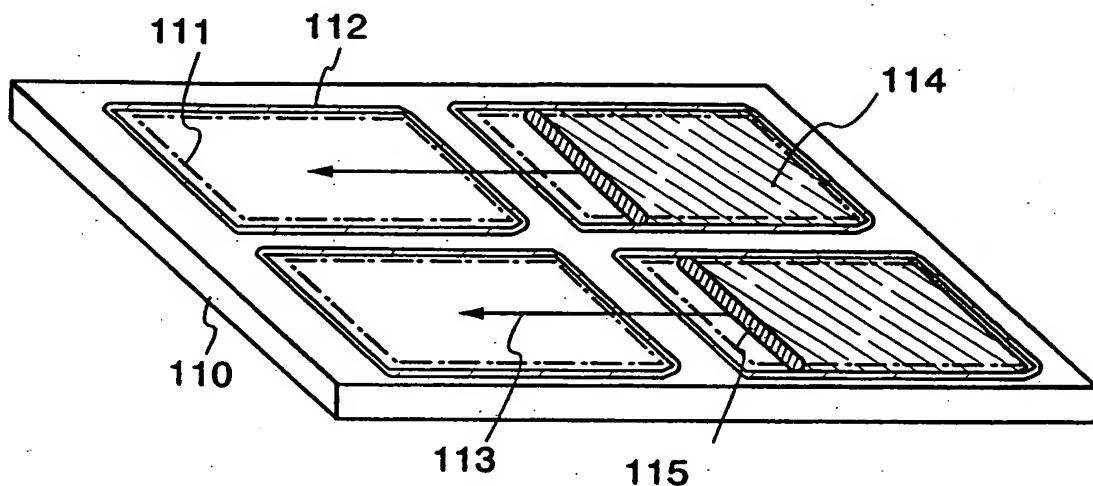


FIG. 11B

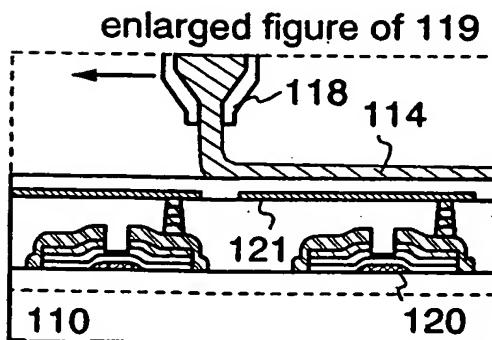


FIG. 11C

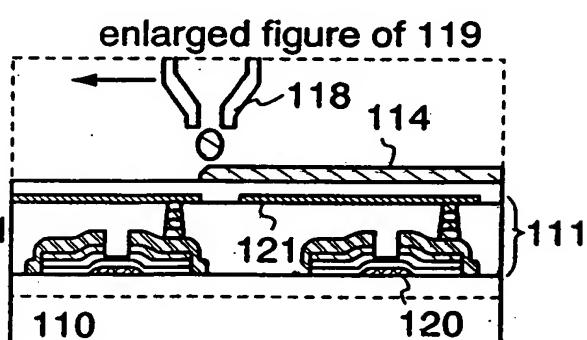


FIG. 11D

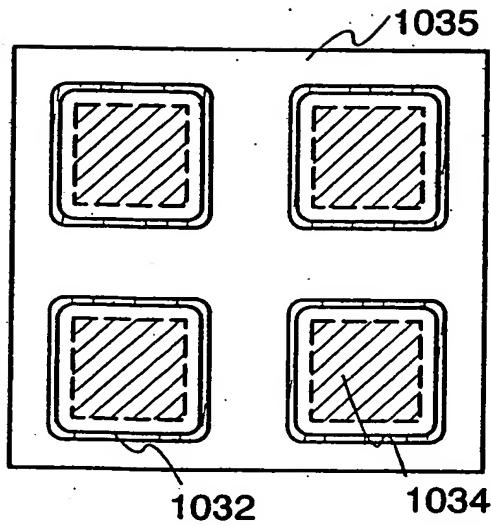


FIG. 12A

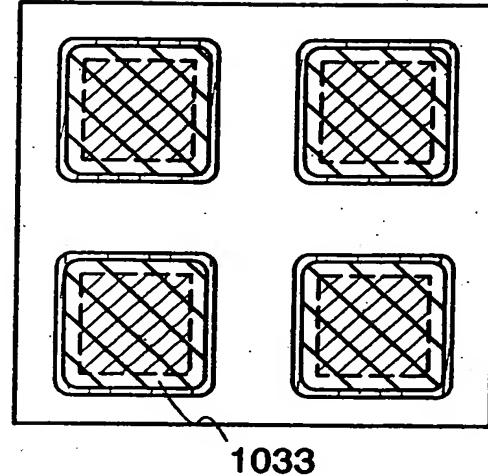


FIG. 12B

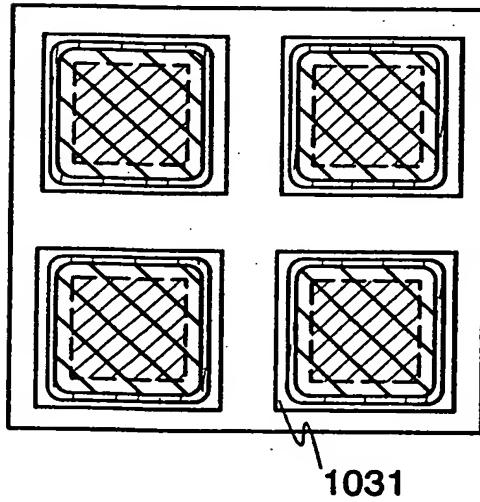


FIG. 12C

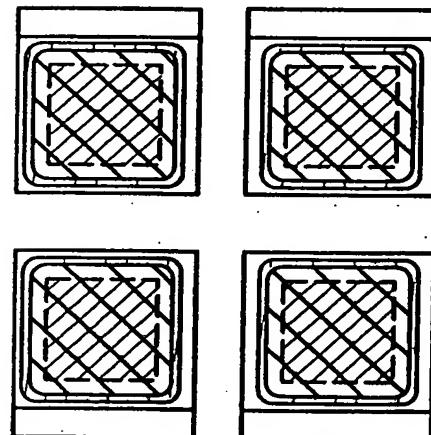


FIG. 12D

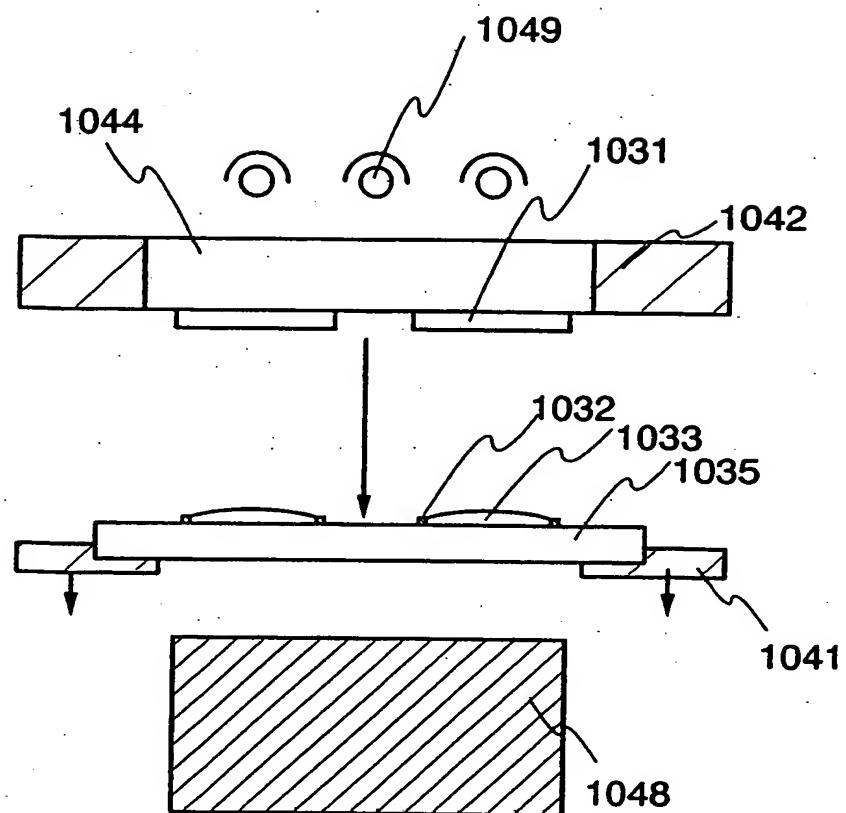


FIG. 13A

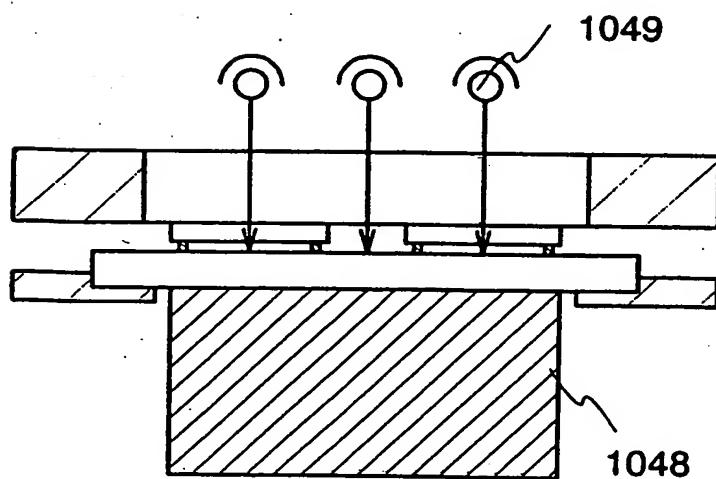


FIG. 13B

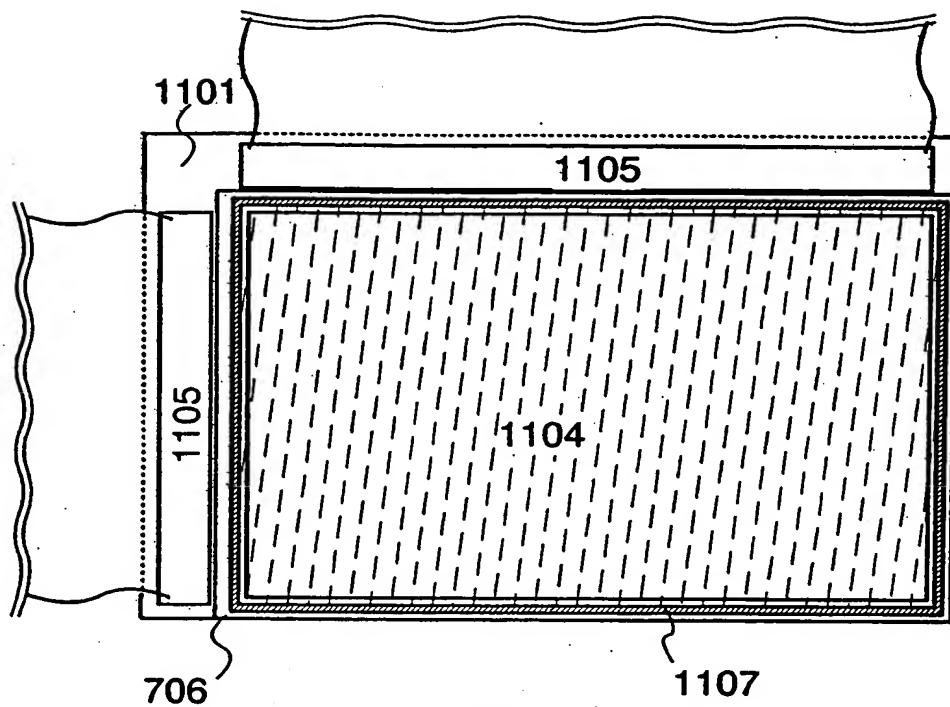


FIG. 14A

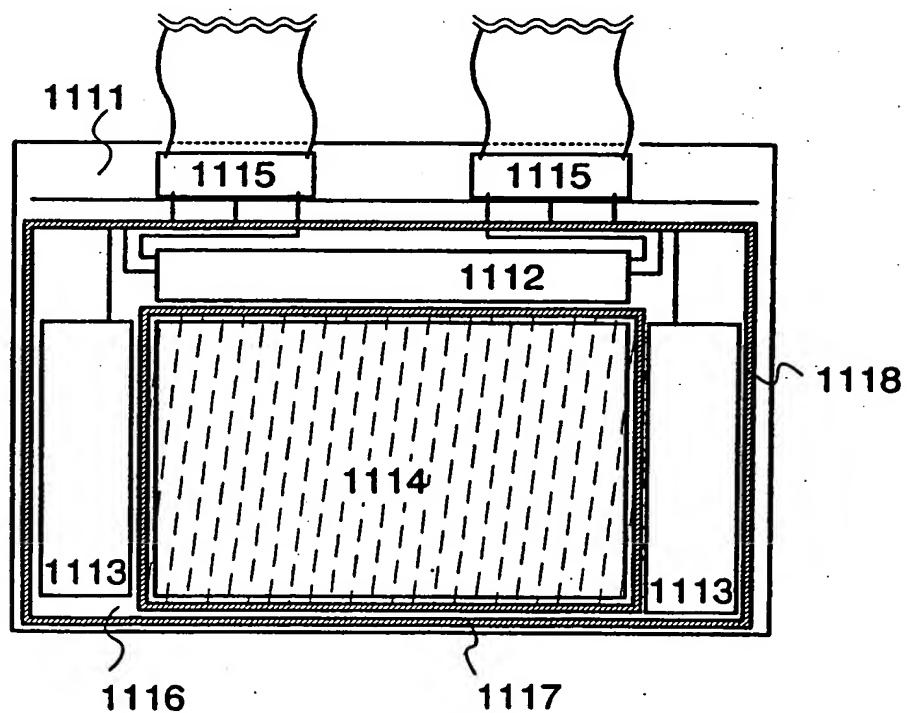


FIG. 14B

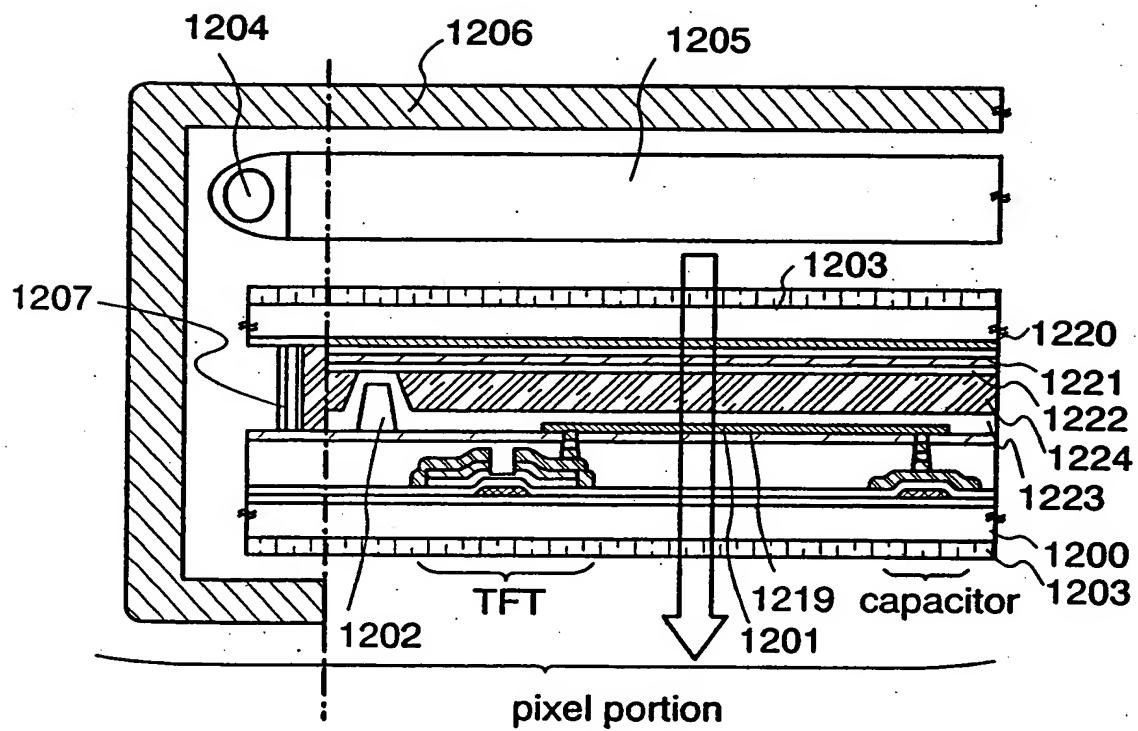


FIG. 15

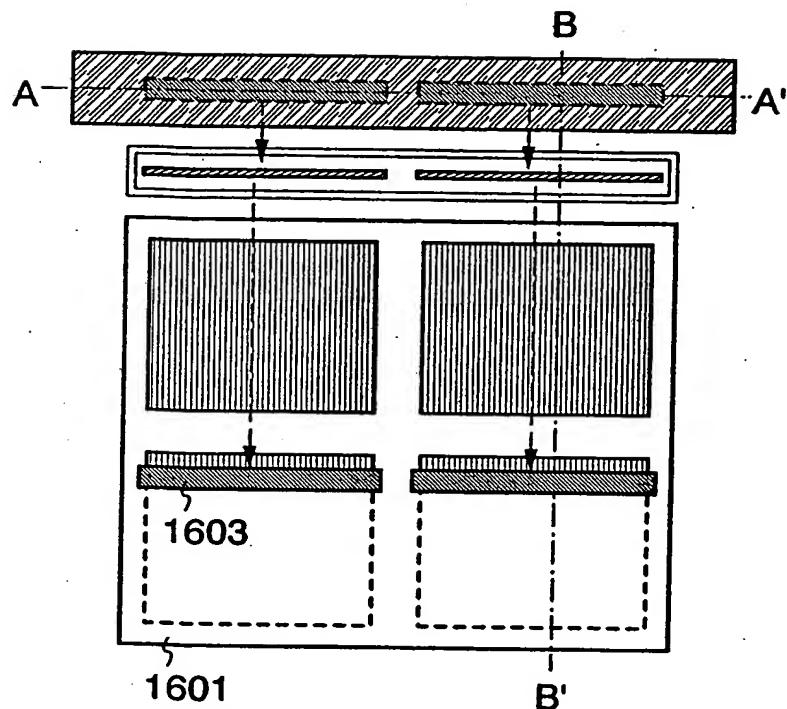


FIG. 16A

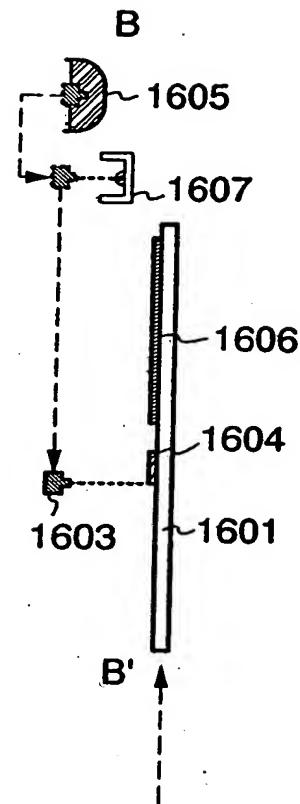


FIG. 16C

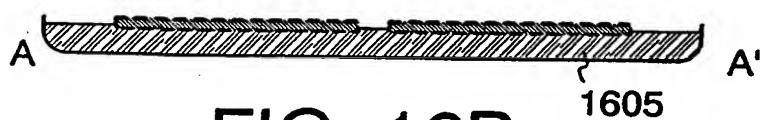


FIG. 16B

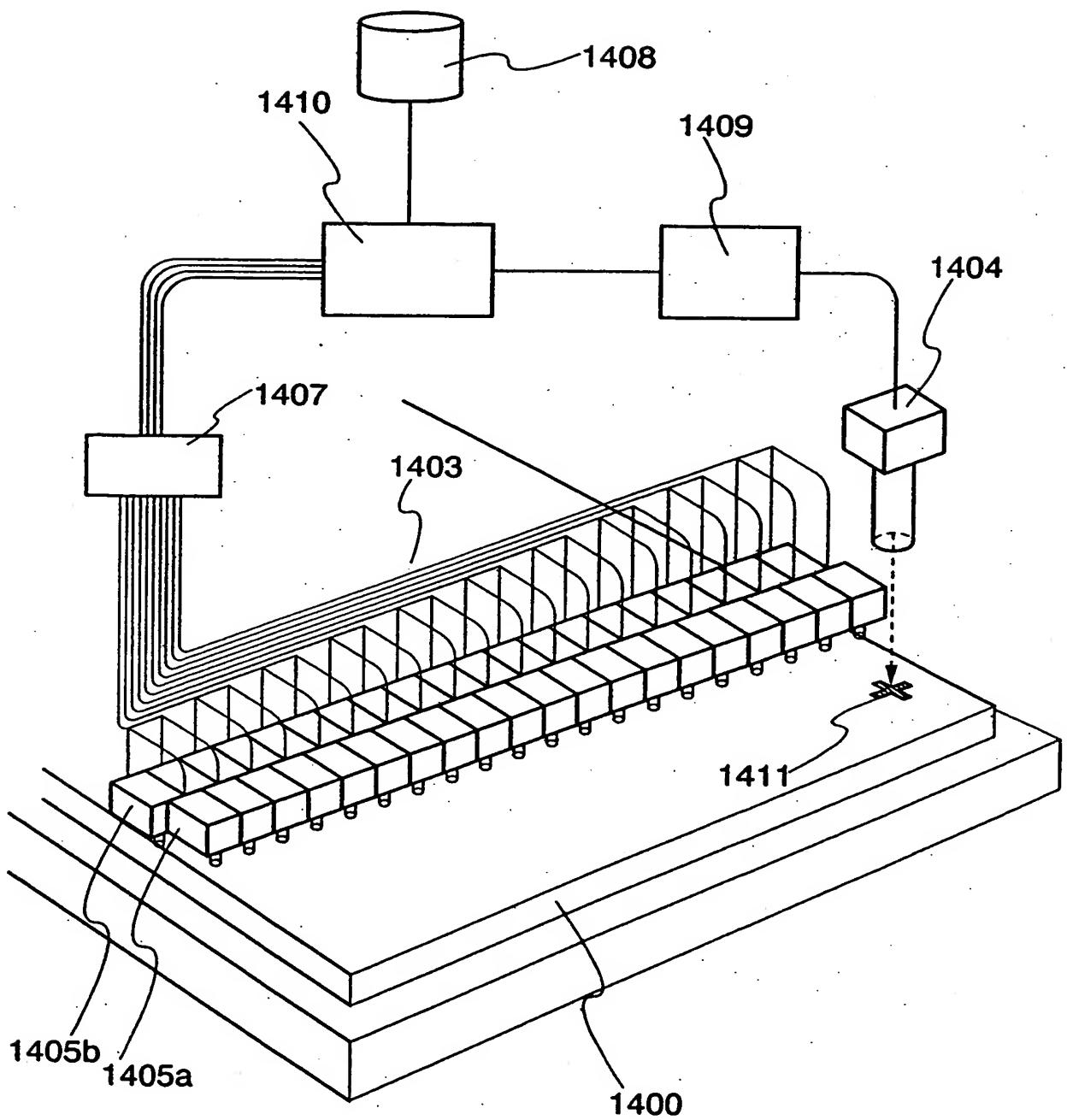


FIG. 17

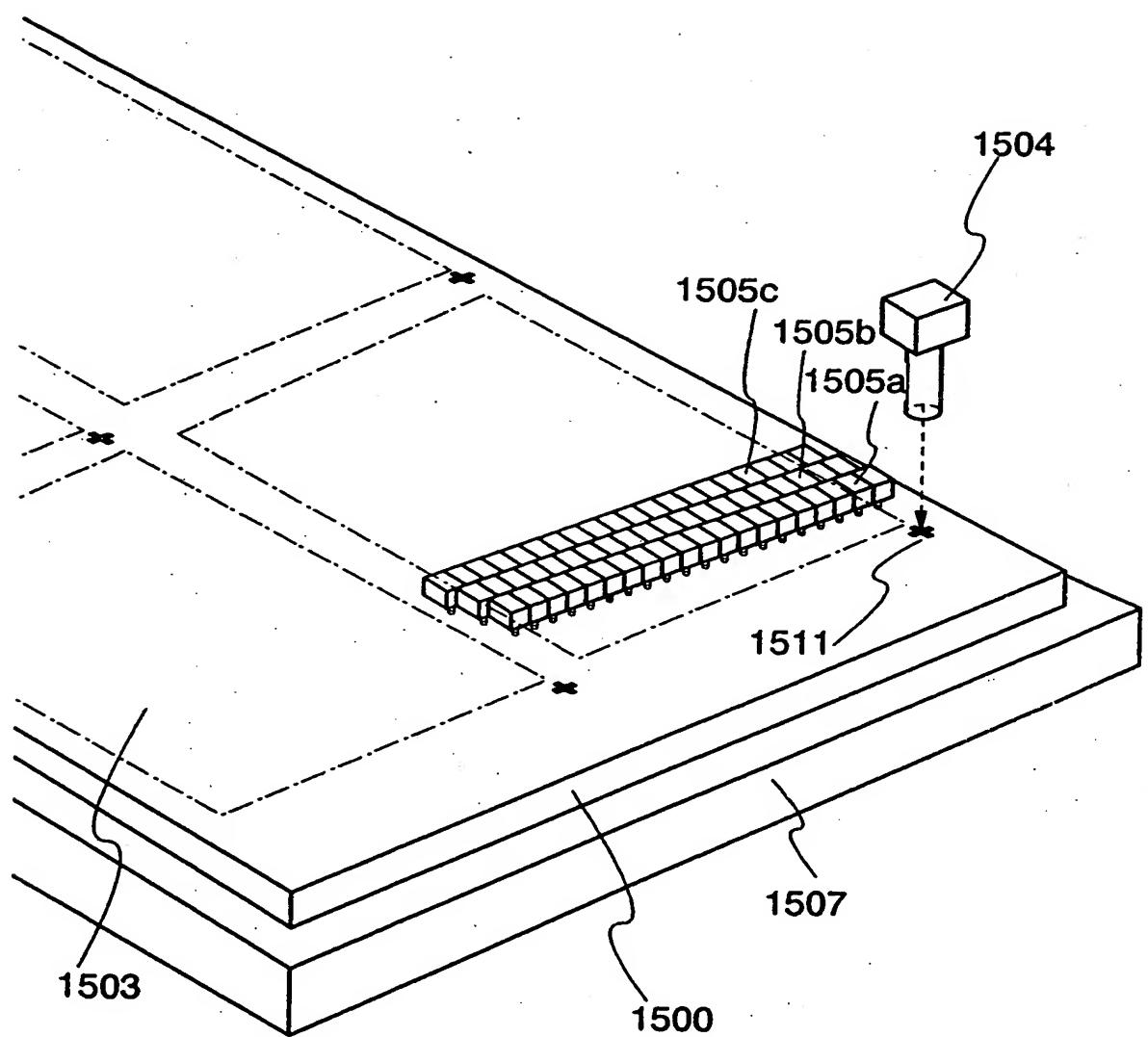


FIG. 18

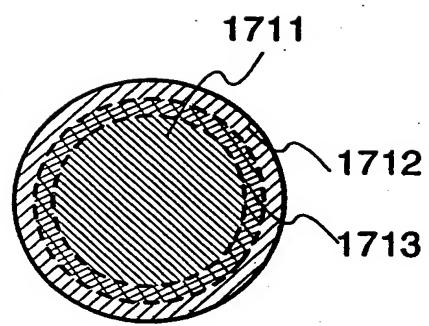
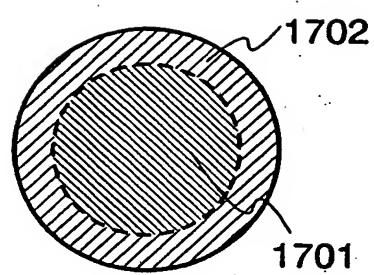


FIG. 19A

FIG. 19B

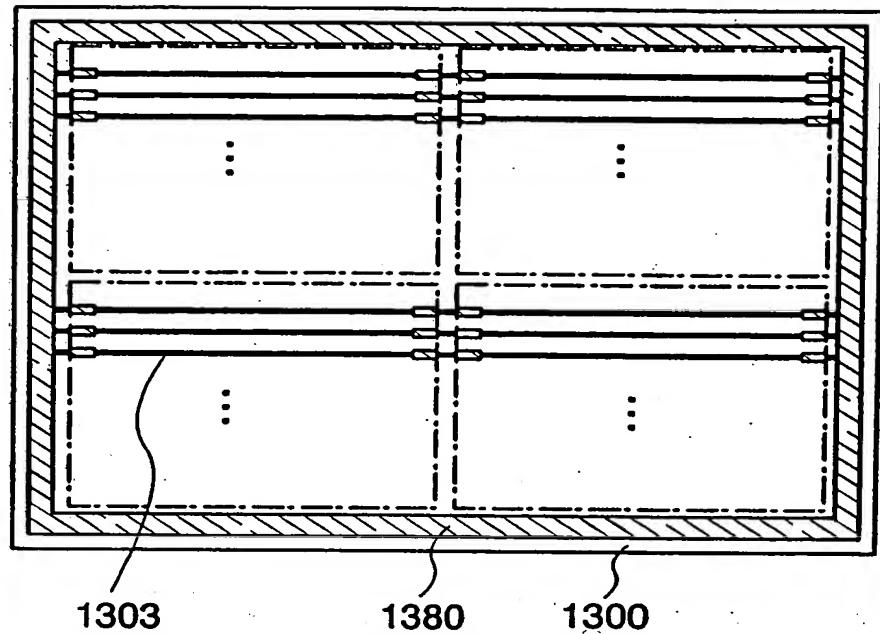


FIG. 20A

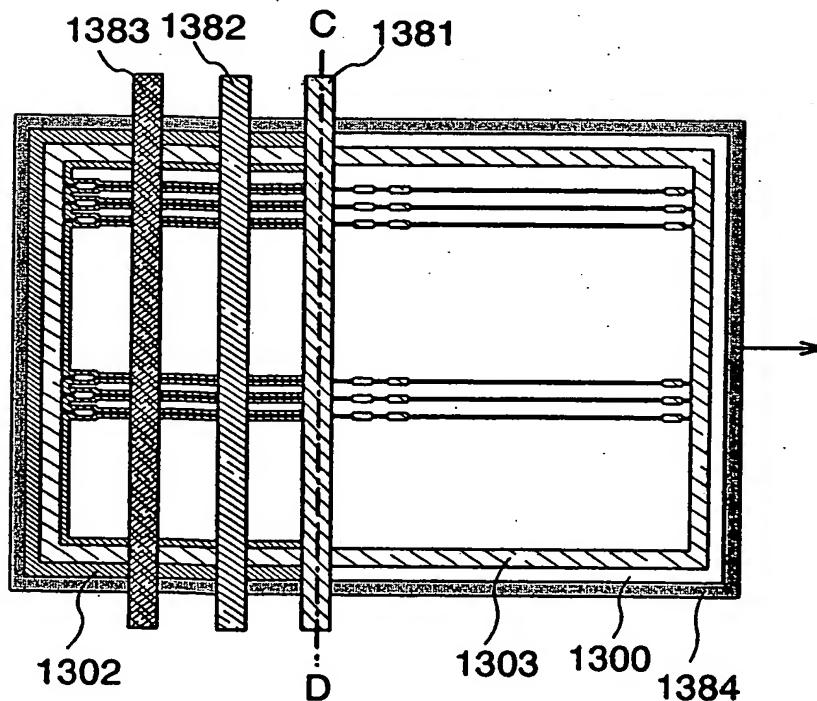


FIG. 20B

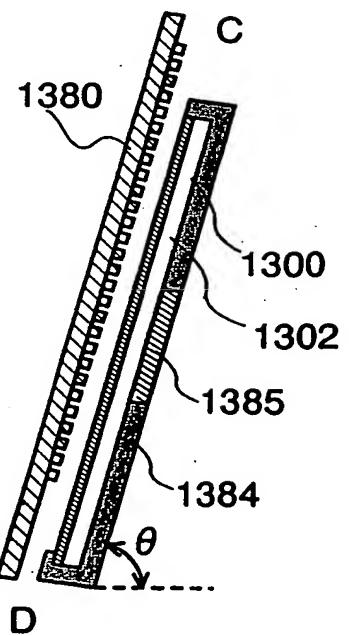


FIG. 20C

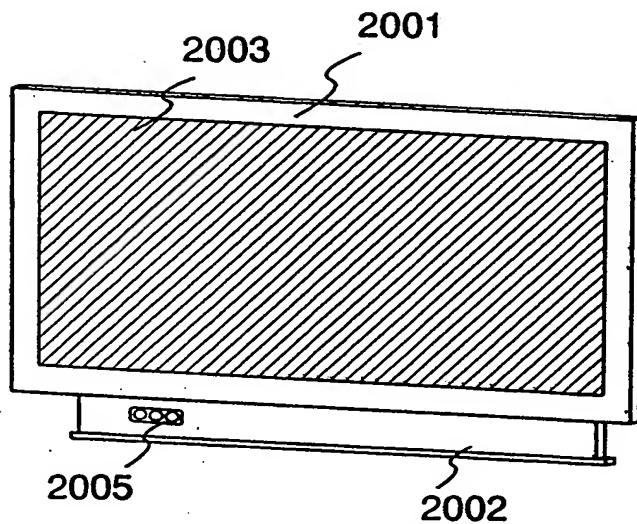


FIG. 21A

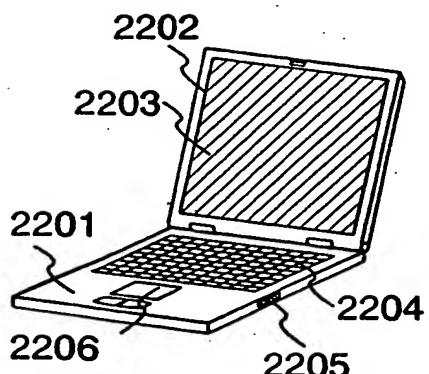


FIG. 21B

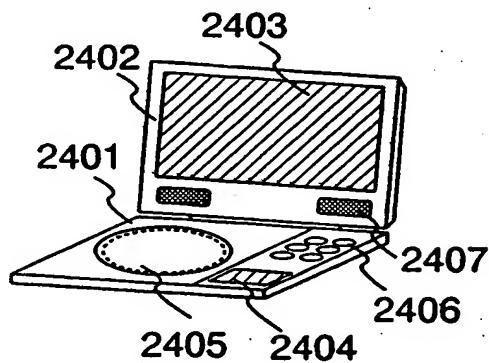


FIG. 21C

EXPLANATION OF REFERENCE

10 a substrate; 11 a base film; 12 a metal wiring; 13 a gate insulating film; 14a a semiconductor film; 14b a semiconductor layer; 15 a mask; 16 an insulating layer; 17 an n-type semiconductor film; 18a a source or drain wiring; 18b a source or drain wiring; 19a a source or drain region; 19b a source or drain region; 20 a projection; 21 an interlayer insulating film; 22 an interlayer insulating film; 23 a pixel electrode; 24a an alignment layer; 24b an alignment layer; 25 a counter substrate; 26a a color layer; 26b a light shielding layer; 27 an overcoat layer; 28 a counter electrode; 29 liquid crystal; 30 a TFT; 31 a capacitor wiring; 40 a wiring; 41 a connection wiring; 42 a conductor; 43 a projection; 44 a terminal electrode; 45 an anisotropic conductive layer; 46 an FPC; 110 a large substrate; 111 a pixel area; 112 a sealant; 113 a nozzle operating direction; 114 a liquid crystal material; 115 an application surface; 116 a droplet discharge system ;118 a nozzle; 119 an area surrounded with dotted lines; 120 an inverted staggered TFT; 121 a pixel electrode; 210 a substrate; 211 a base film ;213 a gate insulating film; 214a a semiconductor film ;214b a semiconductor layer; 215 a mask; 216 an insulating layer; 217 an n-type semiconductor film; 218a a source or drain wiring; 218b a source or drain wiring; 219a a source or drain region; 219b a source or drain region; 221 an interlayer insulating film; 224a an alignment layer; 224b an alignment layer; 225 a counter substrate; 226a a color layer; 226b a light shielding layer; 227 an overcoat layer; 228 a counter electrode; 229 liquid crystal; 230 a TFT; 240 a wiring; 241 a connection wiring; 242 a conductor; 244 a terminal electrode; 245 an anisotropic conductive layer; 246 an FPC; 310 a substrate; 314 a semiconductor layer; 316 an insulating layer; 318a a source or drain wiring; 318b a source or drain wiring; 319a a source or drain region; 319b a source or drain region; 320 a projection; 322 an interlayer insulating film; 323 a pixel electrode; 324a an alignment layer;

324b an alignment layer; 325 a counter substrate; 326a a color layer; 326b a light shielding layer; 327 an overcoat layer; 328 a counter electrode; 329 liquid crystal; 330 a TFT; 340 a wiring; 341 a connection wiring; 342 a conductor; 343 a projection; 344 a terminal electrode; 345 an anisotropic conductive layer; 346 an FPC; 410 a substrate; 411 a base film; 412 a metal wiring; 413 a gate insulating film; 414a a semiconductor film; 414b a semiconductor layer; 415 a mask; 416 a layer formed of an insulating material or a conductive material; 417 an n-type semiconductor film ; 418a a source or drain wiring; 418b a source or drain wiring; 419a an n-type semiconductor film; 419b an n-type semiconductor film; 420 a projection; 421 an interlayer insulating film; 422 an interlayer insulating film; 423 a pixel electrode; 424a an alignment layer; 424b an alignment layer; 425 a counter substrate; 426a a color layer; 426b a light shielding layer; 427 a overcoat layer; 428 a counter electrode; 429 liquid crystal; 430 a TFT; 440 a wiring; 441 a connection wiring; 442 a conductor; 443 a projection; 444 a terminal electrode; 445 an anisotropic conductive layer; 446 an FPC; 510 a substrate; 521 an interlayer insulating film; 524a an alignment layer; 524b an alignment layer; 525 a counter substrate; 526a a color layer; 526b a light shielding layer; 527 an overcoat layer; 528 a counter electrode; 529 liquid crystal; 530 a TFT; 544 a terminal electrode; 545 an anisotropic conductive layer; 546 an FPC; 610 a substrate; 622 an interlayer insulating film; 623 a pixel electrode; 624a an alignment layer; 624b an alignment layer; 625 a counter substrate; 626a a color layer; 626b a light shielding layer; 627 an overcoat layer; 628 a counter electrode; 629 liquid crystal; 630 a TFT; 641 a connection wiring; 644 a terminal electrode; 645 an anisotropic conductive layer; 646 an FPC; 706 a counter substrate; 710 a substrate; 711 a base film; 712 a gate wiring; 713 a gate insulating layer; 714 a semiconductor layer; 718a a source or drain wiring; 718b a source or drain wiring; 719a an n-type semiconductor layer ; 719b an n-type semiconductor layer; 720 a projection; 722 an

interlayer insulating film; 723 a pixel electrode; 724a an alignment layer; 724b an alignment layer; 725 a counter substrates; 726a a color layer; 726b a light shielding layer; 727 an overcoat layer; 728 a counter electrode; 729 liquid crystal; 730 a TFT; 740 a terminal electrode; 743 a projection; 744 a terminal electrode; 745 an anisotropic conductive layer; 746 an FPC; 824a an alignment layer; 824b an alignment layer; 825 a counter substrate; 826a a color layer; 826b a light shielding layer; 827 an overcoat layer; 828 a counter electrode; 829 liquid crystal; 830 a TFT; 840 a connection wiring; 844 a terminal electrode; 845 an anisotropic conductive layer; 846 an FPC; 924a an alignment layer; 924b an alignment layer; 925 a counter substrate; 926a a color layer; 926b a light shielding layer; 927 an overcoat layer; 928 a counter electrode; 929 liquid crystal; 930 a TFT; 940 a connection wiring; 944 a terminal electrode; 945 an anisotropic conductive layer; 946 an FPC; 1031 a second substrate; 1032 a sealant; 1033 liquid crystal; 1034 a pixel area; 1035 a first substrate; 1041 a first substrate holder; 1042 a second substrate holder; 1044 a window; 1048 bottom plate; 1049 a light source; 1101 a substrate; 1104 a pixel area; 1105 an FPC; 1107 a sealant; 1111 a substrate; 1112 a source signal line driver circuit; 1113 a gate signal line driver circuit; 1114 a pixel area; 1115 an FPC; 1116 a counter substrate; 1117 a first sealant; 1118 a second sealant; 1200 a substrate; 1201 a pixel electrode; 1202 a spacer; 1203 a polarizer; 1204 a backlight; 1205 an optical waveguide; 1206 a cover; 1207 a sealant; 1219 a protective film; 1220 a color filter; 1221 a counter electrode; 1222 an alignment layer; 1223 an alignment layer; 1224 a liquid crystal layer; 1300 a substrate; 1302 a conductive film; 1303 a gate electrode; 1380 a conductive film; 1381 a head; 1382 a head; 1383 a head; 1384 a stage; 1385 a stage; 1400 a substrate; 1403 a droplet discharge means; 1404 an imaging means; 1405a a head; 1405b a head; 1407 a control means; 1408 a storage medium; 1409 an image processing means; 1410 a computer; 1411 a marker; 1500 a large

substrate; 1503 an area; 1504 an imaging means; 1505a a head; 1505b a head; 1505c a head; 1507 a stage; 1511 a marker; 1601 a substrate; 1603 a head portions; 1604 a composition; 1605 solvent container; 1606 a composition; 1607 a test stage; 1701 copper; 1702 silver; 1711 copper; 1712 silver; 1713 a buffer layer; 2001 a chassis; 2002 a support; 2003 a display area; 2005 a video input terminal; 2201 a main body; 2202 a chassis; 2203 a display area; 2204 a keyboard; 2205 an external connection port; 2206 a pointing mouse; 2401 a main body; 2402 a chassis; 2403 a display area A; 2404 a display area B; 2405 a recording medium reading part; 2406 an operation key; 2407 a speaker unit

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